



Product Summary

V _(BR) dss	R _{DS(ON)}	I _D T _A = 25°C
	1.8Ω @ V _{GS} = 10V	440mA
60V	2.1Ω @ V _{GS} = 4.5V	410mA

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- DC-DC Converters
- Power management functions

DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.006 grams (approximate)



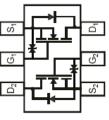


Top View

SOT563



Bottom View



Top View Pin Definition/Schematic

Ordering Information (Note 3)

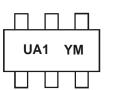
Part Number	Case	Packaging
DMG1026UV-7	SOT563	3000 / Tape & Reel

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



UA1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: X = 2010) M = Month (ex: 9 = September)

Date Code Key

Year	2009		2010	2011		2012	2013		2014	2015		2016
Code	W		Х	Y		Z	А		В	С		D
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteri	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 4) V _{GS} = 10V	Steady State	T _A = 25°C T _A = 85°C	Ι _D	410 300	mA
Continuous Drain Current (Note 5) V _{GS} = 10V	$t \le 10s$	T _A = 25°C T _A = 85°C	I _D	440 320	mA
Continuous Drain Current (Note 4) $V_{GS} = 4.5V$	Steady State	T _A = 25°C T _A = 85°C	ID	380 270	mA
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t ≤ 10s	T _A = 25°C T _A = 85°C	Ι _D	410 295	mA
Pulsed Drain Current (Note 6)	I _{DM}	1.0	А		

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 4)	PD	0.58	W
Thermal Resistance, Junction to Ambient $@T_A = 25^{\circ}C$ (Note 4)	R _{θJA}	213	°C/W
Power Dissipation (Note 5) t ≤ 10s	PD	0.65	W
Thermal Resistance, Junction to Ambient @T _A = 25°C (Note 5) t \leq 10s	R _{0JA}	192	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @ T_A = 25°C unless otherwise stated

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	Cymsol		.,,,,	max	0	
Drain-Source Breakdown Voltage	BV _{DSS}	60	-	-	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current TJ = 25°C	IDSS	-	-	1.0	μA	$V_{DS} = 50V, V_{GS} = 0V$
Cata Caura Lashara		-	-	±50	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±150	nA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	0.5	-	1.8	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance		-	1.2	1.8	Ω	$V_{GS} = 10V, I_D = 500mA$
Static Drain-Source On-Resistance	R _{DS (ON)}	-	1.4	2.1	12	$V_{GS} = 4.5V, I_D = 200mA$
Forward Transfer Admittance	Y _{fs}	80	580	-	mS	$V_{DS} = 10V, I_D = 200mA$
Continuous Source Current (Note 7)	I _S	-	-	200	mA	-
Diode Forward Voltage	V _{SD}	-	0.8	1.3	V	$V_{GS} = 0V, I_{S} = 200mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	-	32	-		
Output Capacitance	Coss	-	4.4	-	pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	2.9	-		T = 1.000112
Gate Resistance	Rg	-	126	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	-	0.45	-		
Gate-Source Charge	Q _{qs}	-	0.08	-	рС	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Q _{gd}	-	0.08	-		$I_D = 250 \text{mA}$
Turn-On Delay Time	t _{D(on)}	-	3.4	-	ns	
Turn-On Rise Time	tr	-	3.4	-	ns	$V_{GS} = 10V, V_{DS} = 30V,$
Turn-Off Delay Time	t _{D(off)}	-	26.4	-	ns	$R_{L} = 150\Omega, R_{G} = 25\Omega,$
Turn-Off Fall Time	t _f	-	16.3	-	ns	$-I_D = 200 \text{mA}$

Notes:

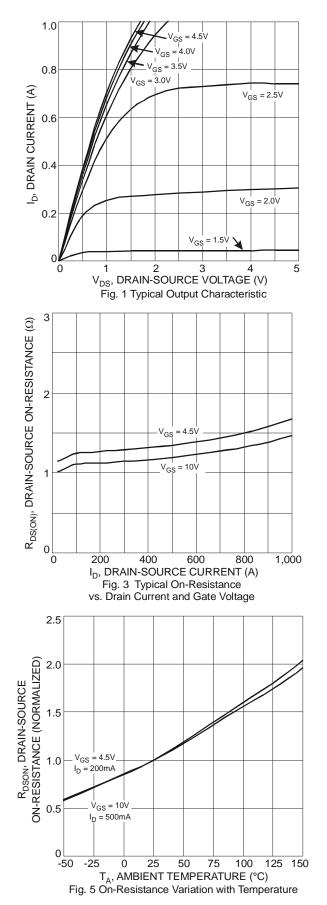
Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
Device mounted on FR-4 PCB with minimum recommended pad layout, measured in t ≤ 10s.

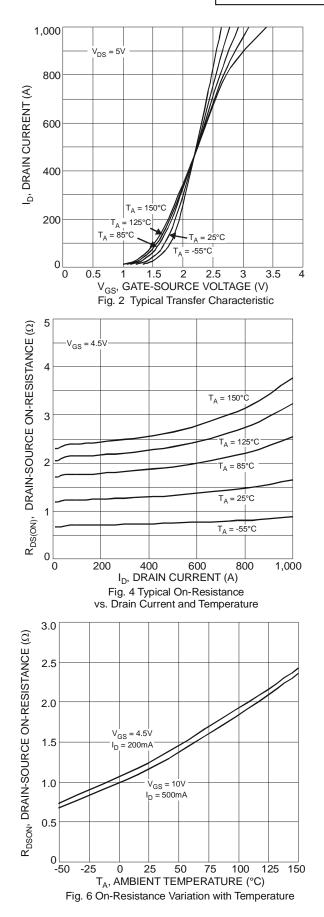
6. Repetitive rating, pulse width limited by junction temperature, 10μ s pulse, duty cycle = 1% 7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.



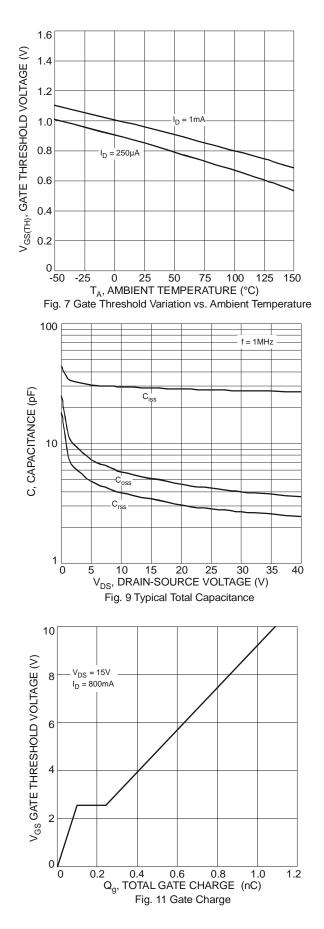
DMG1026UV

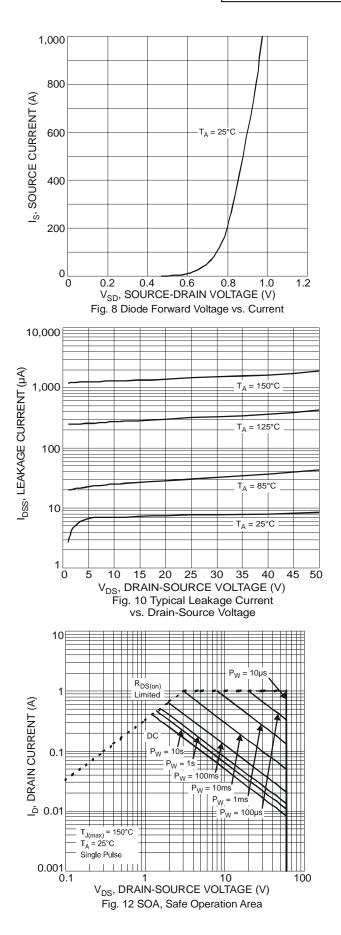




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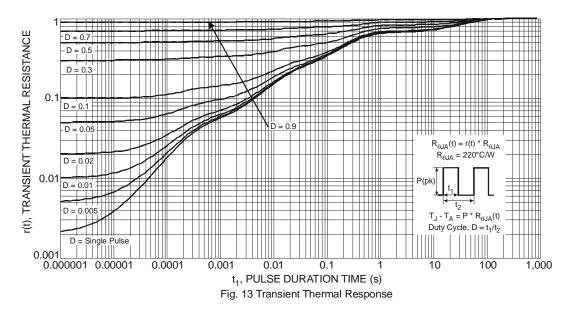




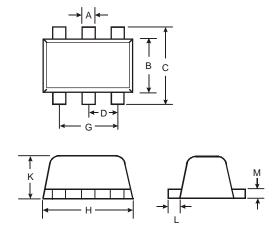


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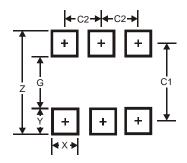


Package Outline Dimensions



SOT563							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.20				
в	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	-	-	0.50				
G	0.90	1.10	1.00				
Η	1.50	1.70	1.60				
Κ	0.55	0.60	0.60				
L	0.10	0.30	0.20				
Μ	0.10	0.18	0.11				
All	All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)				
Z	2.2				
G	1.2				
Х	0.375				
Y	0.5				
C1	1.7				
C2	0.5				



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